

NCP1072, NCP1075

High-Voltage Switcher for Low Power Offline SMPS

The NCP1072/NCP1075 products integrate a fixed frequency current mode controller with a 700 V MOSFET. Available in a PDIP-7 or SOT-223 package, the NCP1072/5 offer a high level of integration, including soft-start, frequency-jittering, short-circuit protection, skip-cycle, a maximum peak current set point, ramp compensation, and a Dynamic Self-Supply (eliminating the need for an auxiliary winding).

Unlike other monolithic solutions, the NCP1072/5 is quiet by nature: during nominal load operation, the part switches at one of the available frequencies (65, 100 or 130 kHz). When the output power demand diminishes, the IC automatically enters frequency foldback mode and provides excellent efficiency at light loads. When the power demand reduces further, it enters into a skip mode to reduce the standby consumption down to a no load condition.

Protection features include: a timer to detect an overload or a short-circuit event, Overvoltage Protection with auto-recovery and AC input line voltage detection.

For improved standby performance, the connection of an auxiliary winding stops the DSS operation and helps to reduce input power consumption below 50 mW at high line.



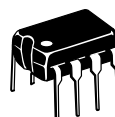
ON Semiconductor®

<http://onsemi.com>

MARKING DIAGRAMS



SOT-223
ST SUFFIX
CASE 318E



PDIP-7
P SUFFIX
CASE 626A



- x = Current Limit (2 or 5)
- y = Oscillator Frequency
A (65 kHz), B (100 kHz), C (130 kHz)
- yyy = 065, 100, 130
- A = Assembly Location
- WL = Wafer Lot
- Y, YY = Year
- W, WW = Work Week
- G or ■ = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 24 of this data sheet.

Features

- Built-in 700 V MOSFET with $R_{DS(on)}$ of 11 Ω
- Large Creepage Distance Between High-voltage Pins
- Current-Mode Fixed Frequency Operation – 65 / 100 / 130 kHz (NCP1072 130 kHz on demand only)
- Peak Current: NCP1072 with 250 mA and NCP1075 with 450 mA
- Fixed Ramp Compensation
- Skip-Cycle Operation at Low Peak Currents Only: No Acoustic Noise!
- Dynamic Self-Supply: No Need for an Auxiliary Winding
- Internal 1 ms Soft-Start
- Auto-Recovery Output Short Circuit Protection with Timer-Based Detection
- Auto-Recovery Overvoltage Protection with Auxiliary Winding Operation
- Frequency Jittering for Better EMI Signature, Including Frequency Foldback Mode
- No Load Input Consumption < 50 mW
- Frequency Foldback to Improve Efficiency at Light Load
- Internal Temperature Shutdown
- These are Pb-Free Devices

Typical Applications

- Auxiliary / Standby Isolated Power Supplies White Goods / Smart Meter / E-Meter

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PIN CONNECTIONS



Figure 1. Pin Connections

INDICATIVE MAXIMUM OUTPUT POWER

$R_{DS(on)} - I_P$	230 Vac	100 – 250 Vac
11 Ω – 450 mA DSS	14 W	7 W
11 Ω – 450 mA Auxiliary Winding	19 W	10 W

NOTE: Informative values only, with $T_{amb} = 50^\circ\text{C}$, $F_{sw} = 65\text{ kHz}$, circuit mounted on minimum copper area as recommended.

QUICK SELECTION TABLE

	NCP1072			NCP1075		
$R_{DS(on)}$ (Ω)	11			11		
I_{peak} (mA)	250			450		
Freq (kHz)	65	100	130	65	100	130
Package	PDIP / SOT223			PDIP / SOT223		

NOTE: NCP1072 130 kHz on demand only.



Figure 2. Typical Application Example

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PIN FUNCTION DESCRIPTION

Pin N°	Pin Name	Function	Pin Description
1	V _{CC}	Powers the internal circuitry	This pin is connected to an external capacitor. The V _{CC} includes an active shunt which serves as an auto-recovery over voltage protection.
2	NC		
3	GND	The IC Ground	
4	FB	Feedback signal input	By connecting an opto-coupler to this pin, the peak current set point is adjusted accordingly to the output power demand.
5	Drain	Drain connection	The internal drain MOSFET connection
6			This un-connected pin ensures adequate creepage distance
7	GND	The IC Ground	
8	GND	The IC Ground	



Figure 3. Simplified Internal Circuit Architecture

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MAXIMUM RATINGS TABLE

Symbol	Rating	Value	Unit	
V _{CC}	Power Supply Voltage on all pins, except Pin 5(Drain)	-0.3 to 10	V	
BV _{dss}	Drain voltage	-0.3 to 700	V	
I _{DS(PK)}	Drain Current Peak during Transformer Saturation	2 x I _{peak(0)}	A	
I _{VCC}	Maximum Current into Pin 1 when Activating the 8.2 V Active Clamp	15	mA	
R _{θJ-A}	P Suffix, Case 626A	0.36 Sq. Inch	77	°C/W
	Junction-to-Air, 2.0 oz Printed Circuit Copper Clad	1.0 Sq. Inch		
R _{θJ-A}	ST Suffix, Plastic Package Case 318E	0.36 Sq. Inch	74	°C/W
	Junction-to-Air, 2.0 oz Printed Circuit Copper Clad	1.0 Sq. Inch		
T _{JMAX}	Maximum Junction Temperature	150	°C	
	Storage Temperature Range	-60 to +150	°C	
	ESD Capability, HBM model (All pins except HV)	2	kV	
	ESD Capability, Machine Model	200	V	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- This device series contains ESD protection and exceeds the following tests:
Human Body Model 2000 V per JEDEC JESD22-A114-F
Machine Model Method 200 V per JEDEC JESD22-A115-A
- This device contains latch-up protection and exceeds 100 mA per JEDEC Standard JESD78

ELECTRICAL CHARACTERISTICS

(For typical values T_J = 25°C, for min/max values T_J = -40°C to +125°C, V_{CC} = 8 V unless otherwise noted)

Symbol	Rating	Pin	Min	Typ	Max	Unit
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SUPPLY SECTION AND V_{CC} MANAGEMENT

V _{CC(on)}	V _{CC} increasing level at which the switcher starts operation	1	7.8	8.2	8.6	V
V _{CC(min)}	V _{CC} decreasing level at which the HV current source restarts	1	6.5	6.8	7.2	V
V _{CC(off)}	V _{CC} decreasing level at which the switcher stops operation (UVLO)	1	6.1	6.3	6.6	V
V _{CC(reset)}	V _{CC} voltage at which the internal latch is reset (guaranteed by design)	1		4		V
V _{CC(clamp)}	Offset voltage above V _{CC(on)} at which the internal clamp activates	1	130	190	300	mV
I _{CC1}	Internal IC consumption, MOSFET switching at 65 kHz	1		0.7	1.0	mA
I _{CCskip}	Internal IC consumption, FB is 0 V (No switching on MOSFET)	1		360		μA

POWER SWITCH CIRCUIT

R _{DS(on)}	Power Switch Circuit on-state resistance NCP107x (I _d = 50 mA) T _J = 25°C T _J = 125°C	5		11 19	16 24	Ω
BV _{DSS}	Power Switch Circuit & Startup breakdown voltage (I _{D(off)} = 120 μA, T _J = 25°C)	5	700			V
I _{DSS(off)}	Power Switch & Startup breakdown voltage off-state leakage current T _J = 125°C (V _{ds} = 700 V)	5		85		μA
t _{on} t _{off}	Switching characteristics (R _L = 50 Ω, V _{DS} set for I _{drain} = 0.7 x I _{lim}) Turn-on time (90% - 10%) Turn-off time (10% - 90%)	5 5		20 10		ns

INTERNAL START-UP CURRENT SOURCE

I _{start1}	High-voltage current source, V _{CC} = V _{CC(on)} - 200 mV	5	5	9	12	mA
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- The final switch current is: I_{PK(0)} / (V_{in}/L_P + S_a) x V_{in}/L_P + V_{in}/L_P x t_{prop}, with S_a the built-in slope compensation, V_{in} the input voltage, L_P the primary inductor in a flyback, and t_{prop} the propagation delay..
- NCP1072 130 kHz on demand only.
- Oscillator frequency is measured with disabled jittering.

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ELECTRICAL CHARACTERISTICS

(For typical values $T_J = 25^\circ\text{C}$, for min/max values $T_J = -40^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{CC} = 8\text{ V}$ unless otherwise noted)

Symbol	Rating	Pin	Min	Typ	Max	Unit
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INTERNAL START-UP CURRENT SOURCE

I_{start2}	High-voltage current source, $V_{CC} = 0\text{ V}$	5		0.5		mA
V_{CCTH}	VCC Transient level for I_{start1} to I_{start2} toggling point	1	-	2.2	-	V

CURRENT COMPARATOR

I_{IPK}	Maximum internal current setpoint at 50% duty cycle FB pin open, NCP1072, $T_J = 25^\circ\text{C}$	-		250		mA
I_{IPK}	Maximum internal current setpoint at 50% duty cycle FB pin open, NCP1075, $T_J = 25^\circ\text{C}$	-		450		mA
$I_{\text{IPK(0)}}$	Maximum internal current setpoint at beginning of switching cycle FB pin open, NCP1072, $T_J = 25^\circ\text{C}$	-	254	282	310	mA
I_{IPKSW}	Final switch current with a primary slope of $200\text{ mA}/\mu\text{s}$, $F_{\text{SW}} = 65\text{ kHz}$, NCP1072 (Note 3)			296		mA
I_{IPKSW}	Final switch current with a primary slope of $200\text{ mA}/\mu\text{s}$, $F_{\text{SW}} = 100\text{ kHz}$, NCP1072 (Note 3)			293		mA
I_{IPKSW}	Final switch current with a primary slope of $200\text{ mA}/\mu\text{s}$, $F_{\text{SW}} = 130\text{ kHz}$, NCP1072 (Notes 3 and 4)			291		mA
$I_{\text{IPK(0)}}$	Maximum internal current setpoint at beginning of switching cycle FB pin open, NCP1075, $T_J = 25^\circ\text{C}$	-	467	508	549	mA
I_{IPKSW}	Final switch current with a primary slope of $200\text{ mA}/\mu\text{s}$, $F_{\text{SW}} = 65\text{ kHz}$, NCP1075 (Note 3)			510		mA
I_{IPKSW}	Final switch current with a primary slope of $200\text{ mA}/\mu\text{s}$, $F_{\text{SW}} = 100\text{ kHz}$, NCP1075 (Note 3)			500		mA
I_{IPKSW}	Final switch current with a primary slope of $200\text{ mA}/\mu\text{s}$, $F_{\text{SW}} = 130\text{ kHz}$, NCP1075 (Note 3)			493		mA
T_{SS}	Soft-start duration (guaranteed by design)	-		1		ms
T_{prop}	Propagation delay from current detection to drain OFF state	-		100		ns

INTERNAL OSCILLATOR

f_{OSC}	Oscillation frequency, 65 kHz version, $T_J = 25^\circ\text{C}$ (Note 5)	-	59	65	71	kHz
f_{OSC}	Oscillation frequency, 100 kHz version, $T_J = 25^\circ\text{C}$ (Note 5)	-	90	100	110	kHz
f_{OSC}	Oscillation frequency, 130 kHz version, $T_J = 25^\circ\text{C}$ (Notes 4 and 5)	-	117	130	143	kHz
f_{jitter}	Frequency jittering in percentage of f_{OSC}	-		± 6		%
f_{swing}	Jittering swing frequency	-		300		Hz
D_{max}	Maximum duty-cycle	-	62	68	72	%

FEEDBACK SECTION

I_{FBfault}	FB current for which Fault is detected	4		-35		μA
$I_{\text{FB100\%}}$	FB current for which internal current set-point is 100% ($I_{\text{IPK(0)}}$)	4		-44		μA
I_{FBfreeze}	FB current for which internal current setpoint is 97 mA (NCP1072) or 158 mA (NCP1075)	4		-80		μA
$V_{\text{FB(REF)}}$	Equivalent pull-up voltage in linear regulation range (Guaranteed by design)	4		3.3		V
$R_{\text{FB(up)}}$	Equivalent feedback resistor in linear regulation range (Guaranteed by design)	4		19.5		k Ω

3. The final switch current is: $I_{\text{IPK(0)}} / (V_{\text{in}}/L_P + S_a) \times V_{\text{in}}/L_P + V_{\text{in}}/L_P \times t_{\text{prop}}$, with S_a the built-in slope compensation, V_{in} the input voltage, L_P the primary inductor in a flyback, and t_{prop} the propagation delay..

4. NCP1072 130 kHz on demand only.

5. Oscillator frequency is measured with disabled jittering.

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ELECTRICAL CHARACTERISTICS

(For typical values $T_J = 25^\circ\text{C}$, for min/max values $T_J = -40^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{CC} = 8\text{ V}$ unless otherwise noted)

Symbol	Rating	Pin	Min	Typ	Max	Unit
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FREQUENCY FOLDBACK & SKIP

I_{FBfold}	Start of frequency foldback feedback level	4		-68		μA
$I_{FBfold(end)}$	End of frequency foldback feedback level, $F_{sw} = F_{min}$	4		-100		μA
F_{min}	The frequency below which skip-cycle occurs	-	21	25	29	kHz
I_{FBskip}	The feedback level to enter skip mode	4		-120		μA
I_{freeze}	Internal minimum current setpoint ($I_{FB} = -90\ \mu\text{A}$) in NCP1072			88		mA
I_{freeze}	Internal minimum current setpoint ($I_{FB} = -90\ \mu\text{A}$) in NCP1075			168		mA

RAMP COMPENSATION

$S_{a(65)}$	The internal ramp compensation in NCP1072 (65 kHz version)	-		4.2		kA/s
$S_{a(65)}$	The internal ramp compensation in NCP1075 (65 kHz version)	-		7.5		kA/s
$S_{a(100)}$	The internal ramp compensation in NCP1072 (100 kHz version)	-		6.5		kA/s
$S_{a(100)}$	The internal ramp compensation in NCP1075 (100 kHz version)	-		11.5		kA/s
$S_{a(130)}$	The internal ramp compensation in NCP1072 (130 kHz version) (Note 4)	-		8.4		kA/s
$S_{a(130)}$	The internal ramp compensation in NCP1075 (130 kHz version)	-		15		kA/s

PROTECTIONS

t_{SCP}	Fault validation further to error flag assertion	-	40	53		ms
$t_{recovery}$	OFF phase in fault mode	-		420		ms
I_{OVP}	V_{CC} clamp current at which the switcher stops pulsing	1	6.0	8.5	11	mA
t_{OVP}	The filter of V_{CC} OVP comparator	-		80		μs
$V_{HV(EN)}$	The drain pin voltage above which allows MOSFET operate, which is detected after TSD, UVLO, SCP, or V_{CC} OVP mode.	5	72	91	110	V

TEMPERATURE MANAGEMENT

TSD	Temperature shutdown (Guaranteed by design)	-	150			$^\circ\text{C}$
	Hysteresis in shutdown (Guaranteed by design)	-		50		$^\circ\text{C}$

- The final switch current is: $I_{PK(0)} / (V_{in}/L_P + S_a) \times V_{in}/L_P + V_{in}/L_P \times t_{prop}$, with S_a the built-in slope compensation, V_{in} the input voltage, L_P the primary inductor in a flyback, and t_{prop} the propagation delay..
- NCP1072 130 kHz on demand only.
- Oscillator frequency is measured with disabled jittering.

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TYPICAL CHARACTERISTICS



Figure 4. V_{CC(on)} vs. Temperature

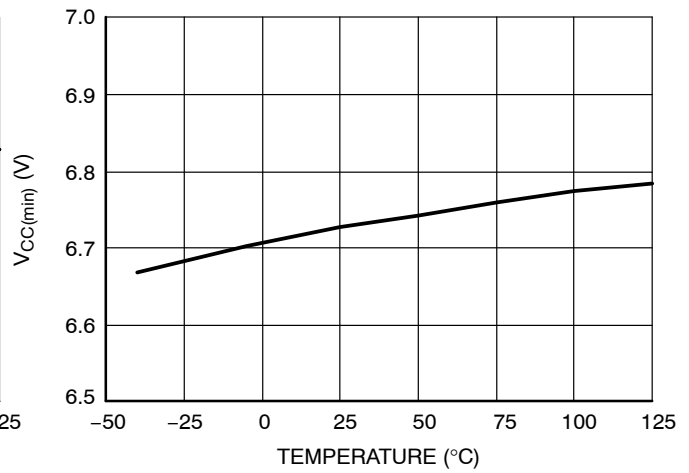


Figure 5. V_{CC(min)} vs. Temperature

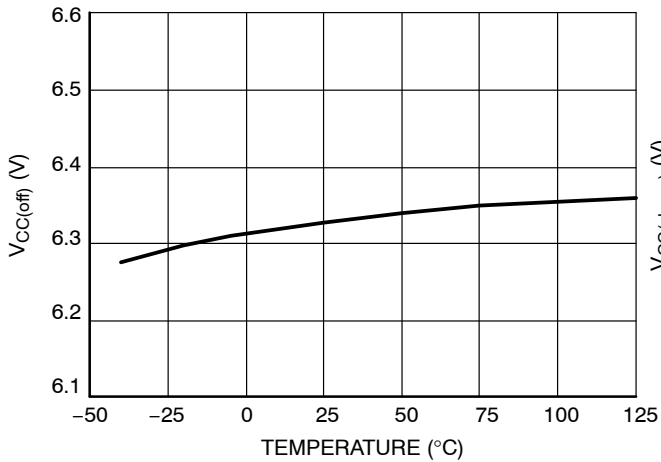


Figure 6. V_{CC(off)} vs. Temperature

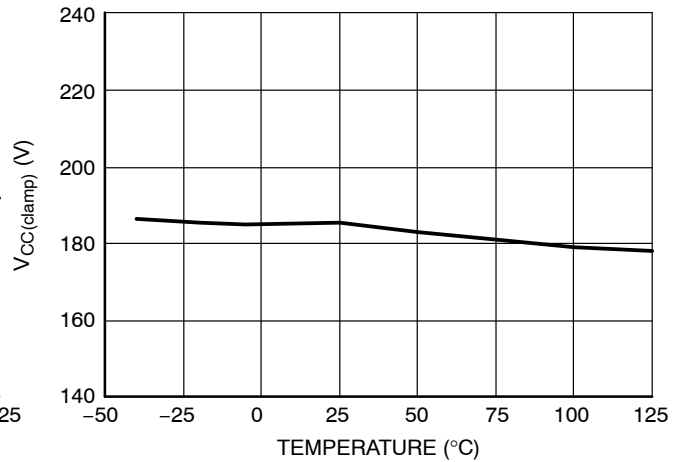


Figure 7. V_{CC(clamp)} vs. Temperature



Figure 8. I_{CC1} vs. Temperature

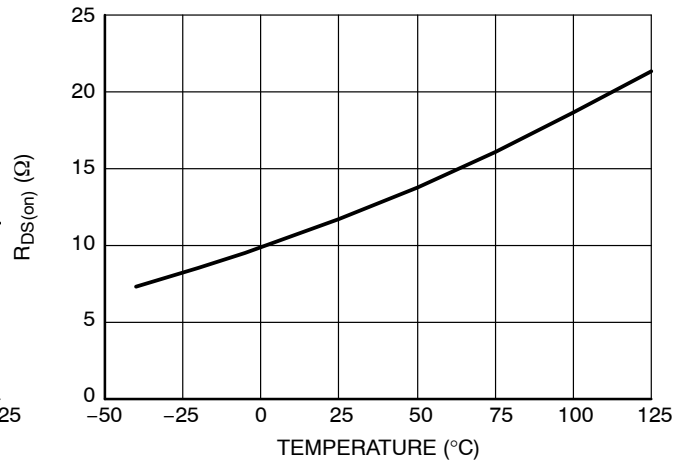


Figure 9. R_{DS(on)} vs. Temperature

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TYPICAL CHARACTERISTICS



Figure 10. $I_{DSS(off)}$ vs. Temperature



Figure 11. I_{start1} vs. Temperature



Figure 12. I_{start2} vs. Temperature



Figure 13. $I_{IPK(0)}$ vs. Temperature



Figure 14. F_{osc} vs. Temperature



Figure 15. $D_{(max)}$ vs. Temperature

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TYPICAL CHARACTERISTICS



Figure 16. F_{min} vs. Temperature



Figure 17. t_{SCP} vs. Temperature



Figure 18. t_{recovery} vs. Temperature



Figure 19. I_{OVP} vs. Temperature



Figure 20. V_{HV(EN)} vs. Temperature

APPLICATION INFORMATION

Introduction

The NCP1072/NCP1075 offers a complete current-mode control solution. The component integrates everything needed to build a rugged and low-cost Switch-Mode Power Supply (SMPS) featuring low standby power. The Quick Selection Table on page 2 details the differences between references, mainly peak current setpoints and operating frequency.

- Current-mode operation: the controller uses current-mode control architecture.
- 700 V – 11 Ω Power MOSFET: Due to ON Semiconductor Very High Voltage Integrated Circuit technology, the circuit hosts a high-voltage power MOSFET featuring a 11 Ω $R_{DS(on)} - T_J = 25^\circ\text{C}$. This value lets the designer build a power supply up to 10 W operated on universal mains. An internal current source delivers the startup current, necessary to crank the power supply.
- Dynamic Self-Supply: Due to the internal high voltage current source, this device could be used in the application without the auxiliary winding to provide supply voltage.
- Short circuit protection: by permanently monitoring the feedback line activity, the IC is able to detect the presence of a short-circuit, immediately reducing the output power for a total system protection. A t_{SCP} timer is started as soon as the feedback current is below threshold, $I_{FB(fault)}$, which indicates the maximum peak current. If at the end of this timer the fault is still present, then the device enters a safe, auto-recovery burst mode, affected by a fixed timer recurrence, $t_{recovery}$. Once the short has disappeared, the controller resumes and goes back to normal operation.
- Built-in V_{CC} Over Voltage Protection: when the auxiliary winding is used to bias the V_{CC} pin (no DSS), an internal active clamp connected between V_{CC} and ground limits the supply dynamics to $V_{CC(clamp)}$. In case the current injected in this clamp exceeds a level of 6.0 mA (minimum), the controller immediately stops switching and waits a full timer period ($t_{recovery}$) before

attempting to restart. If the fault is gone, the controller resumes operation. If the fault is still there, e.g. a broken opto-coupler, the controller protects the load through a safe burst mode.

- Line detection: An internal comparator monitors the drain voltage as recovering from one of the following situations:
 - ◆ Short Circuit Protection,
 - ◆ V_{CC} OVP is confirmed,
 - ◆ UVLO
 - ◆ TSD

If the drain voltage is lower than the internal threshold ($V_{HV(EN)}$), the internal power switch is inhibited. This avoids operating at too low ac input. This is also called brown-in function in some fields.
- Frequency jittering: an internal low-frequency modulation signal varies the pace at which the oscillator frequency is modulated. This helps spreading out energy in conducted noise analysis. To improve the EMI signature at low power levels, the jittering remains active in frequency foldback mode.
- Soft-Start: a 1 ms soft-start ensures a smooth startup sequence, reducing output overshoots.
- Frequency foldback capability: a continuous flow of pulses is not compatible with no-load/light-load standby power requirements. To excel in this domain, the controller observes the feedback current information and when it reaches a level of I_{FBfold} , the oscillator then starts to reduce its switching frequency as the feedback current continues to increase (the power demand continues to reduce). It can go down to 25 kHz (typical) reached for a feedback level of $I_{FBfold(end)}$ (100 μA roughly). At this point, if the power continues to drop, the controller enters classical skip-cycle mode.
- Skip: if SMPS naturally exhibits a good efficiency at nominal load, they begin to be less efficient when the output power demand diminishes. By skipping un-needed switching cycles, the NCP1072/NCP1075 drastically reduces the power wasted during light load conditions.

Fault Condition – Output Short–Circuit

As soon as V_{CC} reaches $V_{CC(on)}$, drive pulses are internally enabled. If everything is correct, the auxiliary winding increases the voltage on the V_{CC} pin as the output voltage rises. During the start–sequence, the controller smoothly ramps up the peak drain current to maximum setting, i.e. I_{PK} , which is reached after a typical period of 1 ms. When the output voltage is not regulated, the current coming through FB pin is below $I_{FB(fault)}$ level (35 μ A typically), which is not only during the startup period but also anytime an overload occurs, an internal error flag is

asserted, $Ipflag$, indicating that the system has reached its maximum current limit set point. The assertion of this flag triggers a fault counter t_{SCP} (53 ms typically). If at counter completion, $Ipflag$ remains asserted, all driving pulses are stopped and the part stays off in $t_{recovery}$ duration (about 420 ms). A new attempt to re–start occurs and will last 53 ms providing the fault is still present. If the fault still affects the output, a safe burst mode is entered, affected by a low duty–cycle operation (11%). When the fault disappears, the power supply quickly resumes operation. Figure 23 depicts this particular mode:



Figure 23. In Case of Short–Circuit or Overload, the NCP107X Protects Itself and the Power Supply Via a Low Frequency Burst Mode. The V_{CC} is Maintained by the Current Source and Self–supplies the Controller.

Auto–Recovery Over Voltage Protection

The particular NCP107X arrangement offers a simple way to prevent output voltage runaway when the optocoupler fails. As Figure 24 shows, an active zener diode monitors and protects the V_{CC} pin. Below its equivalent breakdown voltage, that is to say 8.4 V typical, no current flows in it. If the auxiliary V_{CC} pushes too much current inside the zener, then the controller considers an OVP situation and stops the internal drivers. When an OVP occurs, all switching pulses are permanently disabled. After $t_{recovery}$ delay, it resumes the internal drivers. If the failure symptom still exists, e.g. feedback opto–coupler fails, the device keeps the auto–recovery OVP mode.

Figure 24 shows that the insertion of a resistor (R_{limit}) between the auxiliary dc level and the V_{CC} pin is mandatory a) not to damage the internal 8.4 V zener diode during an overshoot for instance (absolute maximum current is 15 mA) b) to implement the fail–safe optocoupler protection (OVP) as offered by the active clamp. Please note that there cannot be bad interaction between the clamping voltage of the internal zener and $V_{CC(on)}$ since this clamping voltage is actually built on top of $V_{CC(on)}$ with a fixed amount of offset (200 mV typical). R_{limit} should be carefully selected to avoid

triggering the OVP as we discussed, but also to avoid disturbing the V_{CC} in low / light load conditions. The below lines detail how to evaluate the R_{limit} value...

Self–supplying controllers in extremely low standby applications often puzzles the designer. Actually, if a SMPS operated at nominal load can deliver an auxiliary voltage of an arbitrary 16 V (V_{nom}), this voltage can drop below 10 V (V_{stby}) when entering standby. This is because the recurrence of the switching pulses expands so much that the low frequency re–fueling rate of the V_{CC} capacitor is not enough to keep a proper auxiliary voltage. Figure 25 portrays a typical scope shot of a SMPS entering deep standby (output un–loaded). Thus, care must be taken when calculating R_{limit} 1) to not trigger the V_{CC} over current latch (by injecting 6 mA into the active clamp – always use the minimum value for worse case design) in normal operation but 2) not to drop too much voltage over R_{limit} when entering standby. Otherwise, the converter will enter dynamic self supply mode (DSS mode), which increases the power dissipation. Based on these recommendations, we are able to bound R_{limit} between two equations:

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$$\frac{V_{\text{nom}} - V_{\text{CC}(\text{clamp})}}{I_{\text{trip}}} \leq R_{\text{limit}} \leq \frac{V_{\text{stby}} - V_{\text{CC}(\text{min})}}{I_{\text{CCskip}}} \quad (\text{eq. 2})$$

Where:

V_{nom} is the auxiliary voltage at nominal load

V_{stby} is the auxiliary voltage when standby is entered

I_{trip} is the current corresponding to the nominal operation. It thus must be selected to avoid false tripping in overshoot conditions. Always use the minimum of the specification for a robust design, i.e. $I_{\text{trip}} < I_{\text{OVP}}$.

I_{CCskip} is the controller consumption during skip mode.

This number decreases compared to normal operation since the part in standby does almost not switch. It is around 0.36 mA for the 65 kHz version.

$V_{\text{CC}(\text{min})}$ is the level above which the auxiliary voltage must be maintained to keep the controller away from the dynamic self supply mode (DSS mode), which is not a problem in itself if low standby power does not matter.

If a further improvement on standby efficiency is concerned, it is good to obtain V_{CC} around 8 V at no load condition in order not to re-activate the internal clamp circuit.



Figure 24. A More Detailed View of the NCP107X Offers Better Insight on How to Properly Wire an Auxiliary Winding

Since R_{limit} shall not bother the controller in standby, e.g. keep V_{CC} to above $V_{\text{CC}(\text{min})}$ (7.2 V maximum), we purposely select a V_{nom} well above this value. As explained before, experience shows that a 40% decrease can be seen on auxiliary windings from nominal operation down to standby mode. Let's select a nominal auxiliary winding of 13 V to offer sufficient margin regarding 7.2 V when in standby (R_{limit} also drops voltage in standby...). Plugging the values in Equation 2 gives the limits within which R_{limit} shall be selected:

$$\frac{13 - 8.4}{6\text{m}} \leq R_{\text{limit}} \leq \frac{8 - 7.2}{0.36\text{m}}$$

that is to say: $0.77 \text{ k}\Omega < R_{\text{limit}} < 2.2 \text{ k}\Omega$.

If we design a 65 kHz power supply delivering 12V, then the ratio between auxiliary and power must be: $13 / 12 =$

1.08. The OVP latch will activate when the clamp current exceeds 6 mA. This will occur when $V_{\text{auxiliary}}$ grows-up to:

1. $8.4 + 0.77\text{k} \times (6\text{m} + 0.8\text{m}) \approx 13.6 \text{ V}$ for the first boundary ($R_{\text{limit}} = 0.77 \text{ k}\Omega$)
2. $8.4 + 2.2\text{k} \times (6\text{m} + 0.8\text{m}) \approx 23.4 \text{ V}$ for the second boundary ($R_{\text{limit}} = 2.2 \text{ k}\Omega$)

Due to a 1.08 ratio between the auxiliary V_{CC} and the power winding, the OVP will be seen as a lower overshoot on the real output:

1. $13.6 / 1.08 \approx 12.6 \text{ V}$
2. $23.4 / 1.08 \approx 21.7 \text{ V}$

As one can see, tweaking the R_{limit} value will allow the selection of a given overvoltage output level. Theoretically predicting the auxiliary drop from nominal to standby is an

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almost impossible exercise since many parameters are involved, including the converter time constants. Fine tuning of R_{limit} thus requires a few iterations and experiments on a breadboard to check the auxiliary voltage

variations but also the output voltage excursion in fault. Once properly adjusted, the fail-safe protection will preclude any lethal voltage runaways in case a problem would occur in the feedback loop.



Figure 25. The Burst Frequency Becomes so Low That it is Difficult to Keep an Adequate Level on the Auxiliary V_{CC} ...

Figure 26 describes the main signal variations when the part operates in auto-recovery OVP:



Figure 26. If the V_{CC} Current Exceeds a Certain Threshold, an Auto-Recovery Protection is Activated

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Improving the precision in auto-recovery OVP

Given the OVP variations the internal trip current incur, it is sometimes more interesting to explore a different solution, improving the situation to the cost of a minimal amount of surrounding elements. Figure 27 shows that adding a simple zener diode on top of the limiting resistor, offers a better precision since what matters now is the internal 8.4 V V_{CC} breakdown plus the zener voltage. A resistor in series with the zener diodes keeps the maximum current in the V_{CC} pin below the maximum rating of 15 mA just before trip the OVP.



Figure 27. A Simple Zener Diode Added in Parallel



Figure 28. The 1 ms soft-start sequence

Jittering

Frequency jittering is a method used to soften the EMI signature by spreading the energy in the vicinity of the main switching component. The NCP107X offers a $\pm 6\%$ deviation of the nominal switching frequency. The sweep

Soft-Start

The NCP107X features a 1 ms soft-start which reduces the power-on stress but also contributes to lower the output overshoot. Figure 28 shows a typical operating waveform. The NCP107X features a novel patented structure which offers a better soft-start ramp, almost ignoring the start-up pedestal inherent to traditional current-mode supplies:

sawtooth is internally generated and modulates the clock up and down with a fixed frequency of 300 Hz. Figure 29 shows the relationship between the jitter ramp and the frequency deviation. It is not possible to externally disable the jitter.

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Figure 29. Modulation Effects on the Clock Signal by the Jittering Sawtooth

Line Detection

An internal comparator monitors the drain voltage as recovering from one of the following situations:

- Short Circuit Protection,
- V_{CC} OVP is confirmed,
- UVLO
- TSD

If the drain voltage is lower than the internal threshold $V_{HV(EN)}$ (91 Vdc typically), the internal power switch is inhibited. This avoids operating at too low ac input. This is also called brown-in function in some fields.

Frequency Foldback

The reduction of no-load standby power associated with the need for improving the efficiency, requires to change the traditional fixed-frequency type of operation. This device

implements a switching frequency foldback when the feedback current passes above a certain level, I_{FBfold} , set around $68 \mu A$. At this point, the oscillator enters frequency foldback and reduces its switching frequency.

The internal peak current set-point is following the feedback current information until its level reaches I_{freeze} . Below this value, the peak current setpoint is frozen to 88 mA (NCP1072) or 168 mA (NCP1075). The only way to further reduce the transmitted power is to diminish the operating frequency down to F_{min} (25 kHz typically). This value is reached at a feedback current level of $I_{FBfold(end)}$ ($100 \mu A$ typically). Below this point, if the output power continues to decrease, the part enters skip cycle for the best noise-free performance in no-load conditions. Figures 30 and 31 depict the adopted scheme for the part.



Figure 30. By Observing the Current on the Feedback Pin, the Controller Reduces its Switching Frequency for an Improved Performance at Light Load

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Figure 31. I_{pk} Set-point is Frozen at Lower Power Demand.

Feedback and Skip

Figure 32 depicts the relationship between feedback voltage and current. The feedback pin operates linearly as the absolute value of feedback current (I_{FB}) is above $40 \mu A$.

In this linear operating range, the dynamic resistance is $19.5 k\Omega$ typically ($R_{FB(up)}$) and the effective pull up voltage is $3.3 V$ typically ($V_{FB(REF)}$). When I_{FB} is below $40 \mu A$, the FB voltage will jump to close to $4.5 V$.

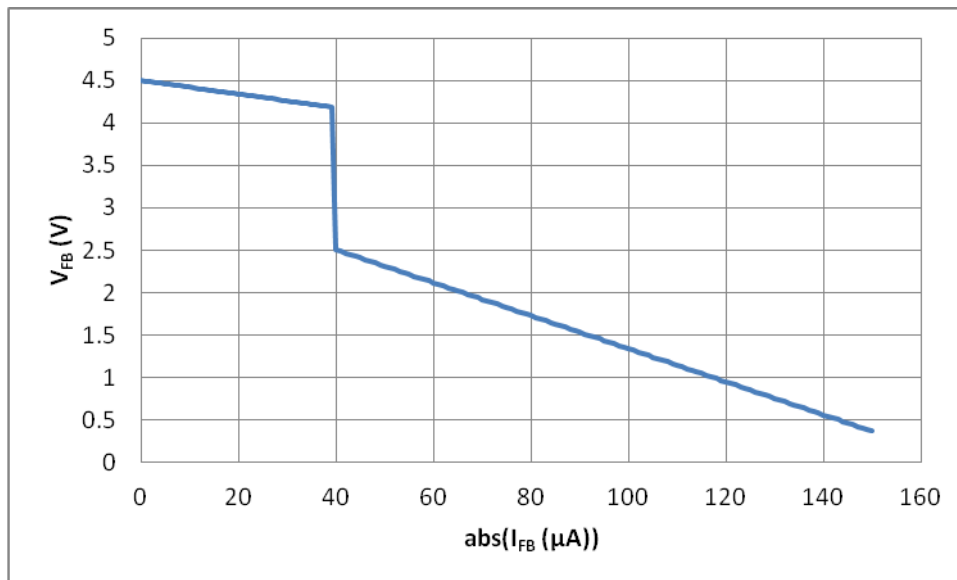


Figure 32. Feedback Voltage vs. Current

Figure 33 depicts the skip mode block diagram. When the FB current information reaches I_{FBskip} , the internal clock to set the flip-flop is blanked and the internal consumption of the controller is decreased. The hysteresis of internal skip

comparator is minimized to lower the ripple of the auxiliary voltage for V_{CC} pin and V_{OUT} of power supply during skip mode. It eases the design of V_{CC} over load range.

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Figure 33. Skip Cycle Schematic

Ramp Compensation and I_{pk} Set-point

In order to allow the NCP107X to operate in CCM with a duty cycle above 50%, a fixed slope compensation is internally applied to the current-mode control.

Here we got a table of the ramp compensation, the initial current set point, and the final current set-point of different versions of switcher.

	NCP1072			NCP1075		
	65 kHz	100 kHz	130 kHz	65 kHz	100 kHz	130 kHz
F_{sw}	65 kHz	100 kHz	130 kHz	65 kHz	100 kHz	130 kHz
S_a	4.2 kA/s	6.5 kA/s	8.4 kA/s	7.5 kA/s	11.5 kA/s	15 kA/s
$I_{pk}(Duty = 50\%)$	250 mA			450 mA		
$I_{pk(0)}$	282 mA			508 mA		

The Figure 34 depicts the variation of I_{PK} set-point vs. the power switcher duty ratio, which is caused by the internal ramp compensation.



Figure 34. I_{PK} Set-point Varies with Power Switch On Time, Which is Caused by the Ramp Compensation

Design Procedure

The design of an SMPS around a monolithic device does not differ from that of a standard circuit using a controller and a MOSFET. However, one needs to be aware of certain characteristics specific of monolithic devices. Let us follow the steps:

$V_{in\ min} = 90\ Vac$ or $127\ Vdc$ once rectified, assuming a low bulk ripple

$V_{in\ max} = 265\ Vac$ or $375\ Vdc$

$V_{out} = 12\ V$

$P_{out} = 10\ W$

Operating mode is CCM

$\eta = 0.8$

1. The lateral MOSFET body–diode shall never be forward biased, either during start–up (because of a large leakage inductance) or in normal operation as shown by Figure 35. This condition sets the

maximum voltage that can be reflected during t_{off} . As a result, the Flyback voltage which is reflected on the drain at the switch opening cannot be larger than the input voltage. When selecting components, you thus must adopt a turn ratio which adheres to the following equation:

$$N(V_{out} + V_f) < V_{in,min} \quad (eq. 3)$$

2. In our case, since we operate from a 127 V DC rail while delivering 12 V, we can select a reflected voltage of 120 Vdc maximum. Therefore, the turn ratio $N_p:N_s$ must be smaller than

$$\frac{V_{reflect}}{V_{out} + V_f} = \frac{120}{12 + 0.5} = 9.6$$

or $N_p:N_s < 9.6$. Here we choose $N = 8$ in this case. We will see later on how it affects the calculation.



Figure 35. The Drain–Source Wave Shall Always be Positive



Figure 36. Primary Inductance Current Evolution in CCM

3. Lateral MOSFETs have a poorly doped body–diode which naturally limits their ability to

sustain the avalanche. A traditional RCD clamping network shall thus be installed to protect the MOSFET. In some low power applications, a simple capacitor can also be used since

$$V_{drain,max} = V_{in} + N(V_{out} + V_f) + I_{peak} \sqrt{\frac{L_f}{C_{tot}}} \quad (eq. 4)$$

where L_f is the leakage inductance, C_{tot} the total capacitance at the drain node (which is increased by the capacitor you will wire between drain and source), N the $N_p:N_s$ turn ratio, V_{out} the output voltage, V_f the secondary diode forward drop and finally, I_{peak} the maximum peak current. Worse case occurs when the SMPS is very close to regulation, e.g. the V_{out} target is almost reached and I_{peak} is still pushed to the maximum. For this design, we have selected our maximum voltage around 650 V (at $V_{in} = 375\ Vdc$). This voltage is given by the RCD clamp

installed from the drain to the bulk voltage. We will see how to calculate it later on.

4. Calculate the maximum operating duty-cycle for this flyback converter operated in CCM:

$$d_{\max} = \frac{N(V_{\text{out}} + V_f)}{N(V_{\text{out}} + V_f) + V_{\text{in,min}}} = \frac{1}{1 + \frac{V_{\text{in,min}}}{N(V_{\text{out}} + V_f)}} = 0.44 \quad (\text{eq. 5})$$

5. To obtain the primary inductance, we have the choice between two equations:

$$L = \frac{(V_{\text{in}}d)^2}{f_{\text{sw}}K P_{\text{in}}} \quad (\text{eq. 6})$$

where

$$K = \frac{\Delta I_L}{I_{\text{Lavg}}}$$

and defines the amount of ripple we want in CCM (see Figure 36).

- ◆ Small K: deep CCM, implying a large primary inductance, a low bandwidth and a large leakage inductance.
- ◆ Large K: approaching BCM where the rms losses are worse, but smaller inductance, leading to a better leakage inductance.

From Equation 6, a K factor of 1 (50% ripple), gives an inductance of:

$$L = \frac{(127 \times 0.44)^2}{65k \times 1 \times 12.75} = 3.8 \text{ mH}$$

$$\Delta I_L = \frac{V_{\text{in,min}} \cdot d_{\max}}{L f_{\text{SW}}} = \frac{127 \times 0.44}{3.8 \times 65k}$$

$$= 223 \text{ mA peak-to-peak}$$

The peak current can be evaluated to be:

$$I_{\text{peak}} = \frac{I_{\text{avg}}}{d} + \frac{\Delta I_L}{2} = I_{\text{peak}} = \frac{98\text{m}}{0.44} + \frac{\Delta I_L}{2} = 335 \text{ mA}$$

On I_L , I_{Lavg} can also be calculated:

$$I_{\text{Lavg}} = I_{\text{peak}} - \frac{\Delta I_L}{2} = 0.34 - 0.112 = 223 \text{ mA}$$

6. Based on the above numbers, we can now evaluate the conduction losses:

$$I_{\text{d,rms}} = \sqrt{d \left(I_{\text{peak}}^2 - I_{\text{peak}} \Delta I_L + \frac{\Delta I_L^2}{3} \right)}$$

$$= \sqrt{0.44 \left(0.335^2 - 0.335 \cdot 0.223 + \frac{0.223^2}{3} \right)}$$

$$= 154 \text{ mA}$$

If we take the maximum $R_{\text{ds(on)}}$ for a 125°C junction temperature, i.e. 24 Ω, then conduction losses worse case are:

$$P_{\text{cond}} = I_{\text{d,rms}}^2 R_{\text{DS(on)}} = 570 \text{ mW}$$

7. Off-time and on-time switching losses can be estimated based on the following calculations:

$$P_{\text{off}} = \frac{I_{\text{peak}}(V_{\text{bulk}} + V_{\text{clamp}})t_{\text{off}}}{2T_{\text{sw}}}$$

$$= \frac{0.335 \times (127 + 120 \cdot 2) \times 10\text{n}}{2 \times 15.4\mu} \quad (\text{eq. 7})$$

$$= 36 \text{ mW}$$

Where, assume the V_{clamp} is equal to two times of reflected voltage.

$$P_{\text{on}} = \frac{I_{\text{valley}}(V_{\text{bulk}} + N(V_{\text{out}} + V_f))t_{\text{on}}}{6T_{\text{sw}}}$$

$$= \frac{0.111 \times (127 + 100) \times 20\text{n}}{6 \times 15.4\mu} \quad (\text{eq. 8})$$

$$= 5.5 \text{ mW}$$

It is noted that the overlap of voltage and current seen on MOSFET during turning on and off duration is dependent on the snubber and parasitic capacitance seen from drain pin. Therefore the t_{off} and t_{on} in Equations 7 and 8 have to be modified after measuring on the bench.

8. The theoretical total power is then 0.570 + 0.036 + 0.0055 = 611 mW
9. If the NCP107X operates at DSS mode, then the losses caused by DSS mode should be counted as losses of this device on the following calculation:

$$P_{\text{DSS}} = I_{\text{CC1}} \cdot V_{\text{in,max}} = 1\text{m} \cdot 375 = 375 \text{ mW} \quad (\text{eq. 9})$$

MOSFET protection

As in any Flyback design, it is important to limit the drain excursion to a safe value, e.g. below the MOSFET BV_{dss} which is 700 V. Figure 37a, b, c present possible implementations:

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Figure 37. Different Options to Clamp the Leakage Spike

Figure 37a: the simple capacitor limits the voltage according to The lateral MOSFET body–diode shall never be forward biased, either during start–up (because of a large leakage inductance) or in normal operation as shown by Figure 35. This condition sets the maximum voltage that can be reflected during t_{off} . As a result, the Flyback voltage which is reflected on the drain at the switch opening cannot be larger than the input voltage. When selecting components, you thus must adopt a turn ratio which adheres to the following equation: Equation 3. This option is only valid for low power applications, e.g. below 5 W, otherwise chances exist to destroy the MOSFET. After evaluating the leakage inductance, you can compute C with Equation 4. Typical values are between 100 pF and up to 470 pF. Large capacitors increase capacitive losses...

Figure 37b: the most standard circuitry is called the RCD network. You calculate R_{clamp} and C_{clamp} using the following formulae:

$$R_{clamp} = \frac{2 V_{clamp} (V_{clamp} - (V_{out} + V_f)N)}{L_{leak} I_{peak}^2 F_{sw}} \quad (\text{eq. 10})$$

$$C_{clamp} = \frac{V_{clamp}}{V_{ripple} F_{sw} R_{clamp}} \quad (\text{eq. 11})$$

V_{clamp} is usually selected 50–80 V above the reflected value $N \times (V_{out} + V_f)$. The diode needs to be a fast one and a MUR160 represents a good choice. One major drawback of the RCD network lies in its dependency upon the peak current. Worst case occurs when I_{peak} and V_{in} are maximum and V_{out} is close to reach the steady–state value.

Figure 37c: this option is probably the most expensive of all three but it offers the best protection degree. If you need a very precise clamping level, you must implement a zener diode or a TVS. There are little technology differences

behind a standard zener diode and a TVS. However, the die area is far bigger for a transient suppressor than that of zener. A 5 W zener diode like the 1N5388B will accept 180 W peak power if it lasts less than 8.3 ms. If the peak current in the worse case (e.g. when the PWM circuit maximum current limit works) multiplied by the nominal zener voltage exceeds these 180 W, then the diode will be destroyed when the supply experiences overloads. A transient suppressor like the P6KE200 still dissipates 5 W of continuous power but is able to accept surges up to 600 W @ 1 ms. Select the zener or TVS clamping level between 40 to 80 V above the reflected output voltage when the supply is heavily loaded.

Power Dissipation and Heatsinking

The NCP107X welcomes two dissipating terms, the DSS current–source (when active) and the MOSFET. Thus, $P_{tot} = P_{DSS} + P_{MOSFET}$. It is mandatory to properly manage the heat generated by losses. If no precaution is taken, risks exist to trigger the internal thermal shutdown (TSD). To help dissipating the heat, the PCB designer must foresee large copper areas around the package. Take the PDIP–7 package as an example, when surrounded by a surface greater than 1.0 cm² of 35 μm copper, it becomes possible to drop its thermal resistance junction–to–ambient, $R_{\theta JA}$ down to 75°C/W and thus dissipate more power. The maximum power the device can thus evacuate is:

$$P_{max} = \frac{T_{Jmax} - T_{ambmax}}{R_{\theta JA}} \quad (\text{eq. 12})$$

which gives around 930 mW for an ambient of 50°C and a maximum junction of 120°C. If the surface is not large enough, assuming the $R_{\theta JA}$ is 100°C/W, then the maximum power the device can evacuate becomes 700 mW. Figure 38 gives a possible layout to help drop the thermal resistance.

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Figure 38. A Possible PCB Arrangement to Reduce the Thermal Resistance Junction-to-Ambient

A 10 W NCP1075 based Flyback Converter Featuring Low Standby Power

Figure 40 depicts a typical application showing a NCP1075–65 kHz operating in a 10 W converter. To leave more room for the MOSFET, it is recommended to disable the DSS by shorting the J3. In this application, the feedback

is made via a NCP431 whose low bias current (50 μ A) helps to lower the no load standby power.

Measurements have been taken from a demonstration board implementing the diagram in Figure 40 and the following results were achieved with auxiliary winding to bias the device:

	100 Vac	115 Vac	230 Vac	265 Vac
No load consumption with auxiliary winding	26 mW	28 mW	38 mW	45 mW



Figure 39. $V_{out} = 12$ V

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Figure 40. A 12 V – 0.85 A Universal Mains Power Supply

ORDERING INFORMATION

Device	Frequency	Package Type	Shipping	Rds(on) ohm	Ipk (mA)
NCP1072STAT3G	65 kHz	SOT-223	4000 / Tape & Reel	11	250
NCP1072STBT3G	100 kHz	SOT-223	4000 / Tape & Reel	11	250
NCP1072P65G	65 kHz	PDIP-7	50 Units / Rail	11	250
NCP1072P100G	100 kHz	PDIP-7	50 Units / Rail	11	250
NCP1075STAT3G	65 kHz	SOT-223	4000 / Tape & Reel	11	450
NCP1075STBT3G	100 kHz	SOT-223	4000 / Tape & Reel	11	450
NCP1075STCT3G	130 kHz	SOT-223	4000 / Tape & Reel	11	450
NCP1075P65G	65 kHz	PDIP-7	50 Units / Rail	11	450
NCP1075P100G	100 kHz	PDIP-7	50 Units / Rail	11	450
NCP1075P130G	130 kHz	PDIP-7	50 Units / Rail	11	450

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ISSUE N



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1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCH.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.50	1.63	1.75	0.060	0.064	0.068
A1	0.02	0.06	0.10	0.001	0.002	0.004
b	0.60	0.75	0.89	0.024	0.030	0.035
b1	2.90	3.06	3.20	0.115	0.121	0.126
c	0.24	0.29	0.35	0.009	0.012	0.014
D	6.30	6.50	6.70	0.249	0.256	0.263
E	3.30	3.50	3.70	0.130	0.138	0.145
e	2.20	2.30	2.40	0.087	0.091	0.094
e1	0.85	0.94	1.05	0.033	0.037	0.041
L	0.20	---	---	0.008	---	---
L1	1.50	1.75	2.00	0.060	0.069	0.078
HE	6.70	7.00	7.30	0.264	0.276	0.287
θ	0°	---	10°	0°	---	10°

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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8 LEAD PDIP CASE 626A ISSUE A



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4. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
5. DIMENSIONS A AND B ARE DATUMS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.40	10.16	0.370	0.400
B	6.10	6.60	0.240	0.260
C	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.78	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	0.76	1.27	0.030	0.050
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	---	10°	---	10°
N	0.76	1.01	0.030	0.040

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